

Attorney Docket No. 431 P002
Customer No. 30358

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In Re U.S. Patent Application of:)
Kwang Hwee Chua and Kin Mun Chew)
)
For: BREADING TABLE)

DECLARATION AND POWER OF ATTORNEY

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled "BREADING TABLE," the Specification of which is attached hereto.

I hereby state that I have reviewed and understand the contents of the above-identified Specification, including the Claims, as amended by any Amendment referred to above.

I acknowledge the duty to disclose information which is material to patentability as defined in 37 C.F.R. § 1.56.

I hereby claim foreign priority benefits under 35 U.S.C. § 119(a)-(d) or § 365(b) of any foreign application(s) for patent or inventor's certificate, or § 365(a) of any PCT international application which designated at least one country other than the United States, listed below and have also identified below any foreign application for patent or inventor's certificate, or PCT international application having a filing date before that of the Application on which priority is claimed:

Prior Foreign Application(s)

Priority
Claimed

<u>D2002/385/Z</u> Number	<u>SINGAPORE</u> Country	<u>23/April/2002</u> Day/Month/Year Filed	<u>X</u> _____ Yes No
------------------------------	-----------------------------	---	--------------------------

Attorney Docket No. 431 P002
Customer No. 30358

PATENT

I hereby claim the benefit under 35 U.S.C. § 119(e) of any United States provisional application(s) listed below:

Application Number

Filing Date

I hereby claim the benefit under 35 U.S.C. § 120 of any United States Application(s), or § 365(c) of any PCT International Application designating the United States, listed below and, insofar as the subject matter of each of the Claims of this Application is not disclosed in the prior United States or PCT International Application in the manner provided by the first paragraph of 35 U.S.C. § 112, I acknowledge the duty to disclose information which is material to patentability as defined in 37 C.F.R. § 1.56 which became available between the filing date of the prior Application and the national or PCT international filing date of this Application:

<u>29/164,003</u>	<u>September 11, 2002</u>	<u>Pending</u>
Application Number	Filing Date	Status

I hereby appoint the following attorney(s) and/or agent(s) to prosecute this Application and transact all business in the Patent and Trademark Office connected therewith.

Marc D. Machtiner, Reg. No. 43,434

Send correspondence and direct telephone calls to:

Marc D. Machtiner, Esq.
Law Office of Marc D. Machtiner, Ltd.
750 W. Lake Cook Road, Suite 350
Buffalo Grove, Illinois 60089
Phone: (847) 537-3537
Fax: (847) 537-0550

I hereby declare all statements made herein of my own knowledge are true and all statements made on information and belief are believed to be true; and further, that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the Application or any patent issued thereon.

Full Name of Sole or First Inventor: Kwang Hwee Chua
Residential Street Address: 35 Lor Ong Lye #05-10, Casa Rosa
City and State/Province: SINGAPORE
Country and Zip/Postal Code: SINGAPORE
Citizenship: SINGAPORE
Mailing Address: Same as above.

Inventor's Signature: _____
Date: _____

Full Name of Sole or First Inventor: Kin Mun Chew
Residential Street Address: 19A Cactus Crescent
City and State/Province: SINGAPORE
Country and Zip/Postal Code: SINGAPORE, S.809754
Citizenship: SINGAPORE
Mailing Address: Same as above.

Inventor's Signature: _____
Date: _____